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Surface Modified Nano-SiO₂ Enhances Dielectric Properties of Stator Coil Insulation for HV Motors

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ABSTRACT

Nano-SiO₂ particles were doped into epoxy resin (EP) to fabricate the main insulation used for high voltage (HV) motors. The EP-based nanocomposite with different mass ratios of nano-SiO₂ particles (0.5, 1, 2.5, and 5 wt%) were prepared. Surface morphology and conductivity of samples were tested, and AC breakdown strength was measured at different temperatures. The mechanisms for the tailoring of dielectric properties of EP were discussed. The optimal doping scheme (0.5 wt%) was selected and used as the base material in preparation of a stator coil insulation for 6 kV motors. The dielectric properties, including dielectric loss and leakage current as well as partial discharge, were tested, and the potential application of nano-SiO₂ particles in the stator coil insulation of HV motors was discussed. The test results showed that the doped nano-SiO₂ particle into dielectric composite used as the main insulation material for HV motors can be an optimal candidate to improve the above mentioned properties especially dielectric losses and electrical breakdown strengths. The results in this paper offer references and a guiding significance for the application of nano-SiO₂ in the insulation of HV motors.

Index Terms — Nanocomposite; epoxy resin; nano silica; dielectric strength; HV motors.

1 INTRODUCTION

THE increase in motor capacity and the reduction of motor size have always been a contradiction. This problem is more prominent for HV motors operating in some special environment, e.g. in the coal mine, the vessel or the high-speed train. Due to limited operating environment in special environment, it is very difficult to achieve high capacity with relative smaller size for HV motors [1]. The key parameter which allows the determination of the size of motors is the thickness of the main insulation of the stator coils, which is also the most vulnerable part of HV motors [2]. Therefore, in order to improve the electrical properties of the main insulation, the use of proper materials is a critical issue for HV motors since it could allow the realization of HV motors with larger capacity and smaller size.

The most common dielectric materials used in the main

insulation of HV motors are: tung-maleic anhydride adhesive epoxy resin (TMEP) and tung-maleic epoxy resin glass mica paper tape (EPMT). EPMT is mainly made of powder mica paper, glass-fiber fabric, and adhesive resin. Powder mica paper and glass-fiber fabric are inorganic materials with good electrical properties. Therefore, the applicability of EPMT in HV motors mainly depends on the characteristics of the adhesive resin. Epoxy resin is not only the main component of adhesive resin in mica tape but also the main component of impregnating resin used during the process of vacuum pressure impregnation of main insulation. Therefore, the key to improving the properties of the main insulation for HV motors lies on the improvement of epoxy resin properties [3].

Doping of nanofillers is a useful way to tailor the property of dielectric materials [4, 5]. Studies show that nanoparticles added to the insulation materials are mainly distributed among the polymer chains and play a positive role in improving the

property of insulating materials [6-8]. Weidner *et al* modified the epoxy mica with different contents of nano-SiO₂. They found that the electrical and thermal properties are enhanced by nano particles [9]. Dettmer *et al* proposed an idea to wind a motor coil with nanoparticles filled XLPE insulation layers to accomplish a "cable-wound motor". The electric field strength of the coil increased by approximately 2.3 times [10]. However, since the mechanical modulus of polyethylene resin is small, the winding can easily loosen or vibrate under the action of a large electromagnetic force during operation [10].

In this paper, surface-modified nano-SiO₂ particles are doped in epoxy resin, and samples with different doping ratios were prepared. Based on the dielectric property measurement results, the optimal doping ratio (0.5 wt%) was selected and used as the base material in preparation of a 6 kV stator coil. The dielectric properties of this bar were tested and the potential application of nano-SiO₂ particles in the stator coil insulation of HV motors was discussed.

2 EXPERIMENTAL

2.1 PREPARATION OF SAMPLES

The epoxy resin used in this paper is a low molecular bisphenol A epoxy resins (E-51). The epoxy value is 0.48–0.51 and the viscosity is 11000-14000 mPa·s/25°C. The diameter of the nano-SiO₂ ranges from 7 nm to 50 nm. The nano-SiO₂ based nanocomposite was prepared with nano-SiO₂ mass ratio of 0.5, 1, 2.5 and 5 wt%. The small-sized samples are labeled as S_0, S_0.5, S_1, S_2.5, and S_5, with 10 mm of diameter and 0.3 mm of thickness. The curing agent is methyl hexahydrophthalic anhydride (MHHPA) and the release agent used for the demolding of samples is GA-7500 solvent-based release agent. The preparation process of nano-SiO₂ based epoxy resins is described as follows: (1) Clean the mold with acetone and absolute ethanol for two times and dry the mold at 80 °C for 30 minutes. (2) Spray the liquid release agent evenly on the mold surface and place the mold in a drying oven for at least 3 hours at 120 °C. (3) Dry the nano-SiO₂ particles at 120 °C for 12 hours. (4) Place the epoxy resin in a drying oven at 60 °C for 30 minutes. Mix the nano-SiO₂ into the epoxy resins and mechanically stir with a speed of 4000 r/min for 1 hour at 60 °C. (5) Add the hardener, the accelerator to the epoxy resin accordingly and stir the composite with a speed of 3000 r/min at 80 °C for 5 minutes. After that, place the mixtures in a vacuum drying oven at 80 °C for about 30 minutes for the vacuuming process. (6) Pour the mixed liquid into the preheated mold and place the mold in the drying oven at 120 °C for 90 minutes. Finally, take out the mold and cool it down naturally. The manufacturing process can be depicted in Figure 1.

A stator coil of the 6 kV motor using epoxy with a doped nano-SiO₂ ratio of 0.5 wt% was prepared according to the industrial preparation method in a motor repairing workshop [11]. The insulating material of the stator coil was mica tape doped with 0.5 wt% nano-SiO₂. The mica tape has a mica content of 82±6 g/m², a glass cloth content of 36±4 g/m², and an adhesive content of 74±9 g/m². The mica tape has a width

of 25 ± 1 mm and a thickness of 0.14 ± 0.02 mm. This stator coil was measured and a commercial 6 kV stator coil without doping with nanoparticles was also measured as a comparison. It is worth noting that the stator coils used in this experiment are the commercialized 6kV coils and no semi-conductive coating was applied on the surface of these coils.

Figure 1. Preparation process of EP/SiO₂ composites. (a) Weighing appropriate amount of epoxy resin, (b) adding SiC fillers, (c) adding hardener and stirring at 60 °C, (d) adding curing agent and stirring at room temperature, (e) vacuum degassing, (f) surface coating on spacers, (g) curing at room temperature for 12h, and (h) curing at 80 °C for 12 h.

2.2 CHARACTERIZATION

The surface morphology was observed using SEM (JSM-6700F, Nippon Electronics Co., Ltd.).

The bulk conductivity measurement was carried out using a high resistance meter (Keithley 6517B). At first, samples with a thickness of 300 μm were electrically short-circuited for 5 minutes to eliminate internal charges and then a constant DC electric field of 2 kV/mm was applied to the samples for 10 minutes with the leakage current being recorded.

The dynamic thermo-mechanical analysis (DMA) test was performed using a Netzsch DMA242, Germany. During the measurement, the rate of change of temperature during heating and cooling was 5 °C/min between 30 and 200 °C. The force and the displacement were 3 N and 10 μm at 1, 5, and 10 Hz.

DC breakdown tests were performed on a dielectric strength tester with controllable temperature using film samples with a thickness of about 300 μm. The samples were sandwiched between two copper cylindrical electrodes with a diameter of 20 mm and immersed in the oil to avoid surface flashover. The applied DC voltage was increased at a rate of 50 V/s to breakdown. The temperatures of oil during measurement were 20, 40, 80, 120, 140, 155 and 180 °C. Ten points were tested for each sample and a two-parameter Weibull distribution was used to analyze the obtained data.

The trap distribution of samples was calculated according to the space charge distribution at the depolarization phase as is reported in literature [12]. Space charge decay characteristics of samples during depolarization were measured by a pulsed electro-acoustic (PEA) technique, and the current density was obtained through the average charge density of samples. Assuming that the released carriers are no longer captured by

traps, the trap level, E_t , and the trap level density, $N(E_t)$, can be calculated respectively according to the following equations:

$$E_t = kT \ln(vt) \quad (1)$$

$$N(E_t) = \frac{\eta_2}{\eta_1} \frac{t}{\tau} e^{-t/\tau} \quad (2)$$

where k is Boltzmann's constant, 8.61×10^{-5} eV/K; T is the absolute temperature; v is the electronic vibration frequency, 3×10^{12} Hz; η_1 is $qdkT/4$, q is the quantity of electric charge, 1.6×10^{-19} C; η_2 is 1.2×10^{-10} A/d; τ and A are the constants in the exponential function; d is the thickness of specimen.

The dielectric loss measurement was performed using an AI6000 dielectric loss instrument whose schematic diagram is shown in Figure 2. The output voltage was 0~10 kV, 50 Hz sinusoidal voltage, and the dielectric loss measurement accuracy was $\pm(\text{result} \times 1\% + 0.00040)$. The temperature control box was used to control the temperature of the coil, with an accuracy of $\pm 1\%$ F.S. Before the measurement, the conductor of the coil was connected to the high voltage end of AI6000, and then the copper foil was wounded as a measuring electrode in a straight section of the coil. The copper foil had a width of 50 mm and a thickness of 0.2 mm. Secondly, the copper foil was wrapped as a protective electrode with a distance of 4 mm away from both sides of the measuring electrode. The width of the copper foil for the protective electrode was 20 mm, with the same thickness as the measuring electrode. Finally, the measuring electrode was connected to the measuring section of AI6000 via a shielded cable, while the protective electrode was grounded. Before the measurement, the temperature was set to a constant value and kept for 30 min, then the voltage was increased to the desired value and the dielectric loss of the stator coil was measured.

Figure 2. Measurement systems of dissipation factor for stator coils.

The PD was measured by a PD analyzer (OMICRON MPD600) whose experimental setup is shown in Figure 3. A High Frequency Current Transformers (HFCT) sensor (HVPD HFCT 100/50) was clipped around the ground wire to measure partial discharge pulses.

Figure 3. Schematic diagram of PD measurement system.

3 RESULTS AND DISCUSSION

3.1 SURFACE MORPHOLOGY

The morphology of the experimental samples is shown in Figure 4. The surface is very smooth and there are no local mutation of surface roughness can be found in Figure 4 (a). It is observed from Figure 4 (b), (c) and (d) that the SiO_2 nanoparticles are uniformly distributed in the epoxy matrix at low nanoparticle loadings (0.5, 1, and 2.5wt%). When the nano- SiO_2 content increases to 5wt%, a small amount of micro-sized aggregates appear (as shown in Figure 4 (e)). As concluded in previous researches, these aggregates of nanoparticles are probably the origins of material degradation of the nanocomposites [13, 14].

Figure 4. SEM images of experimental samples.

3.2 CONDUCTIVITY ANALYSIS

Figure 5 shows the DC conductivity of EP nanocomposites at room temperature. The conductivity of EP nanocomposites initially decreases and then increases with the increase of

nanoparticles. When the content of nanoparticles is 0.5 wt% and 1 wt%, the conductivity of EP nanocomposites is lower than that of pure EP. The bulk conductivity of S_2.5 is almost the same as the S_0. However, it is worth noting that when the doping ratio is 5 wt%, the bulk conductivity increases up to 2.3×10^{-14} S/m, which is 2.5 times larger than S_0.5 and S_1.

Figure 5. DC bulk conductivity of EP/SiO₂ composites.

3.3 DYNAMIC MECHANICAL ANALYSIS

Dynamic mechanical analysis (DMA) is based on the modulus of elasticity of the material to determine the glass transition temperature (T_g). Therefore, from the viewpoint of molecular chain motion, when the temperature rises to T_g , the polymer segment starts to move and the material enters a high elastic state. As can be seen from Figure 6, the T_g of different samples ranged from 130 °C to 140 °C. When the doping amount is 0.5 wt%, the T_g shows the highest value (about 140 °C), and when the doping amount is further increased, the T_g tends to decrease. This phenomenon is likely imputed to the interfaces in the insulation system, which can play a decisive role in T_g improvement. A small amount of nanoparticles (0.5 wt%) evenly distributed in the matrix can introduce a large number of interfaces, which enhances the physical and chemical cross-linking of the system and limits further the movement of the polymer molecular chains and increases the T_g . As the nano-content increases, agglomeration occurs between particles, and the interface regions can overlap, resulting in an additional free volume in the epoxy matrix.

Figure 6. T_g measurement results of pure EP and EP/SiO₂.

3.4 BREAKDOWN ELECTRIC FIELD STRENGTH

According to the Weibull distribution, the cumulative probability P of electrical breakdown can be expressed as:

$$P(x) = 1 - \exp \left[- \left(\frac{E}{\alpha} \right)^\beta \right] \quad (3)$$

where α and β represent scale and shape parameters, and E represents short-term breakdown electric field strength. The Weibull distribution of breakdown strength of epoxy resins with the different nano-particle content at room temperature is shown in Figure 7.

Figure 7. Weibull distribution of AC Breakdown strength

It can be seen that the dielectric strength of epoxy resin is significantly changed after the introduction of nano-SiO₂. The breakdown strength of EP nanocomposites increases first and then decreases with the increase of nano-SiO₂ content. When the content of nano-particle is 0.5wt%, the breakdown strength of the nanocomposite reaches the highest value which is about 19.0% higher than the one of pure EP. It can be seen from Table 1 that the scale parameter is consistent with the variation law of breakdown strength, while the addition of nanoparticles leads to the increase of the shape parameter. For example, when the content of nano particles is 0.5wt%, the shape parameter is 2 times higher than the one related to the pure epoxy resin. The best result is achieved when the content of nanoparticles is 0.5wt%, which is more than 2 times of pure epoxy resin. This indicates that the addition of nano-SiO₂ reduces the dispersion of breakdown strength and makes the internal structure of the material more compact.

Table 1. Weibull distribution parameters of AC breakdown.

	S_0	S_0.5	S_1	S_2.5	S_5
β	29.10	68.51	51.65	51.72	39.90
α	46.87	55.85	51.68	50.91	45.42

Figure 8 shows the curve of AC dielectric strength as a function of temperature for samples characterized by different content of nanoparticles. It can be noticed that the AC dielectric strength of all samples gradually decreases with the increase of

temperature. When the temperature is higher than 120 °C, the AC dielectric strength decreases faster with respect to lower temperatures. Moreover, the breakdown electric field strength of S 0.5 results is higher than the one of the other samples, especially when temperature is more than 120 °C.

Figure 8. AC dielectric strength at different temperatures.

3.5 CHARACTERIZATION OF 6 KV STATOR COILS DOPED WITH 0.5 WT% NANO-SiO₂

Figure 9 shows the trend of the dissipation factor of experimental stator coils at different temperatures for doped sample with 0.5wt% nano-SiO₂, where it is shown that the dielectric losses of both coils increase with temperature. This trend is more pronounced when the temperature is above 120 °C. Coils doped with nanoparticles at different temperatures have lower dielectric losses, especially for temperatures above 120 °C.

Moreover, the dissipation factor tip-up per kilo volt was calculated by

$$\Delta \tan \delta = \tan \delta_{HV} - \tan \delta_{LV} \quad (4)$$

where $\tan \delta_{HV}$ and $\tan \delta_{LV}$ respectively represent the value of dielectric loss between each successive voltage value. For example, $\tan \delta$ at 1kV has been subtracted from $\tan \delta$ at 2 kV, and $\tan \delta$ at 6 kV has been subtracted from $\tan \delta$ at 7 kV.

The dependency of dissipation factor tip-up per kilovolt versus temperature has been reported in Figure 9b. When temperature is higher than about 120 °C, the dissipation factor tip-up of the mica coil is clearly larger than that of the nanocomposite coil. At 155 °C, the dissipation factor tip-up of the mica coil is about 2.6% / kV, while the dissipation factor tip-up of the nanocomposite coil is 2.1% / kV. Therefore, nano-fillers can reduce the dielectric loss of the coil to a certain extent, especially when local temperature increases.

Figure 10 shows the leakage current curve of the two coils at 5 kV DC at 25 °C (measurement system winding connection is the same as Figure 3). It is worth noting that the leakage current of both coils decays with time and the current stability value of the nanocomposite coil results less than 0.3 nA (lower than 0.8 nA of the undoped coil). Considering the stabilized current value to calculate the insulation resistance, the insulation resistance of the undoped coil and the doped coil are about 5~9 TΩ and 25 TΩ, respectively. Therefore, the

insulation resistance of the coil is slightly increased after doping the nanoparticles.

Figure 9. Under different voltages and temperatures: samples' (a) dissipation factor and (b) dissipation factor tip-up.

Figure 10. Leakage current of stator coil under DC voltage.

3.6 PARTIAL DISCHARGE ANALYSIS

Figure 11 shows the PRPD of the pure stator coil and the nano-SiO₂ doped stator coil at 2 kV and 6 kV, respectively. It can be found that the doping of SiO₂ has potential effects on the inner discharge and the partial discharge on the surface. As an example, when 2 kV was applied, some PDs occurred in the positive half voltage cycle with the amplitude of 10 pC for

the nano SiO_2 doped coil. This phenomenon can be due to PDs taking place within small voids inside the main wall insulation. Moreover, when the voltage is up to 6 kV, PDs in the triple junction between the insulation, the air, and the grounded metal can be detected for the nano- SiO_2 doped coil. Similarly, for the pure coil, PDs can also be found at 6 kV. However, the repetition rate for the PD pulses with the amplitude ranging from 100 pC to 5000 pC for pure stator coil is much higher than the nano- SiO_2 doped stator coil. It is known that the glass-reinforced epoxy mica can withstand inter-

nal discharge for decades, while surface PDs in the winding could have more energy, which can be a potential disadvantage for the safe operation of the HV machine [15].

4 MECHANISMS FOR PROPERTY IMPROVEMENT

4.1 GRAFTING OF NANOPARTICLES

Figure 12 shows the FTIR spectra of the investigated samples. There is a distinct absorption peak at 805 cm^{-1} , which corresponds to the stretching vibration of Si-O-Si bond [16]. Absorption peaks at 1630 cm^{-1} can be found in all samples, corresponding to the bending vibration of hydroxyl (-OH). This indicates that either the surface of nanoparticles Hydroxyl groups are present on the surface of the particles, or water molecules are adsorbed on the surface of the particles [17]. The sample after doping with SiO_2 shows a lower absorption peak than the undoped sample. Moreover, the doped sample has a distinct absorption peak at 2921 cm^{-1} , corresponding to the stretching vibration of C-H in the coupling agent [18]. The coupling agent can react with -OH on the surface of SiO_2 to form a -Si-O-Si covalent bond, thereby to produce a stronger connection. The methylene group in KH550 showed a distinct peak at 1250 cm^{-1} compared to the undoped sample, indicating that KH550 has successfully modified the nano- SiO_2 particles. The peaks of $S_{2.5}$ and S_5 near 3500 cm^{-1} do not significantly vary compared with pure EP. The possible reason could be found in the content of nanoparticles. The increase in their concentration, in fact, leads to the agglomeration of the particles resulting in a wider interface region.

Figure 11. PRPD of stator coils at different voltages.

Figure 12. FTIR of spectra of experimental samples.

4.2 DIELECTRIC STRENGTH MODIFICATION

The trap distribution of EP nanocomposites is shown in Figure 13. When the content of nanoparticles increases from 0wt% to 5wt%, both the level and density of shallow traps initially increase, then decrease. However, the depth of the traps nanocomposites stays still higher than pure EP. When the contents are 0.5wt% and 1wt%, the increase of shallow traps depth and density will affect the carrier migration process inside the material. The deep traps level also rises with the content of nano-particles.

Figure 13. Trap distribution of EP nanocomposites.

The effect of nano-SiO₂ on the dielectric strength of EP is closely related to the interface regions formed between the EP matrix and the nano-fillers. The hydroxyl groups on the surface of the nano-SiO₂ react with the hydroxyl groups from hydrolysis of the coupling agent, which forms a Si-O-Si bond. The other end of the coupling agent reacts with the EP to form a covalent bond. In Figure 14, the nano-SiO₂ particles are presented as blue spheres. The nano-SiO₂ and EP matrix combine by the mean of a coupling agent leading to a large number of interfacial regions in the material. According to the multi-region structure of spherical nano-particles [19], the interface region consists of bonded region and transition region, as shown in Figure 15. Polymer chains are arranged randomly in epoxy matrix, and relatively orderly in the interfacial region, bringing to a relatively high conduction region in the transition region.

Figure 14. Reaction of silane coupling agent with EP and nano-SiO₂

Figure 15. Potential barrier model around nanoparticles.

When nanoparticles are evenly dispersed in the epoxy resin matrix, the relationship between nanoparticle spacing and specific surface area and the content of nano-SiO₂ can be expressed as follows [20],

$$D = d \left\{ \left[\frac{\pi 100 \rho_1}{6C \rho_2} \left[1 - \frac{C}{100} \left(1 - \frac{\rho_2}{\rho_1} \right) \right] \right]^{1/3} - 1 \right\} \quad (5)$$

$$S = \frac{\pi d^2}{(D+d)^3} = \pi \left(\frac{d}{D+d} \right)^2 \frac{1}{D+d} \quad (6)$$

where d is the diameter of nano-particles; D is the spacing between nano-particles; S is the specific surface area of nano-particles; ρ_1 and ρ_2 represent the density of nano-particles and EP; C represents the mass fraction of nano-particles.

When the content of nanoparticles is lower than 1wt%, it can be seen from the equation (5) and (6) that with the increase of the nanoparticles, the spacing D of nanoparticles decreases rapidly, the specific surface area S increases gradually, and the proportion of the internal interface area per unit volume increases gradually. According to the multi-core model for polymer nanocomposite [21], the increase of the volume of the interface region leads to an increase in carrier trapping probability during the migration process. On the other hand, it can be seen from the trap distribution that the addition of low-content nanoparticles greatly increases the depth and density of traps in the matrix. It is generally believed that traps can capture carriers and thus inhibit the transfer of carriers.

The charge distribution and potential energy barrier model near the nanoparticles are shown in Figure 15, where EC stands for the bottom of the conduction band and E_V for the top of the valence band, while E_F and E_g stands for Fermi energy level and forbidden band, respectively [22]. It is worth noting that a strong internal electric field exists in the bonded region on the surface of nano-particles. The width and barrier height of the bonded region are d_1 and ϕ , respectively. The corresponding space charge layer and its barrier heights between the interface region and the matrix are d_2 and ϕ , respectively. To maintain the electrical neutrality around nanoparticles, some net charges accumulate in the matrix near the interface region and compensate for the charges captured in both the bonded region and the transition region, which forms a potential barrier ϕ . Due to the low height of the barrier ϕ the carriers in the matrix can easily jump through ϕ into the transition region under the action of an external electric field. It can be seen from the trap level distribution that there are a large number of deep traps in the transition region when the content of nanoparticle is low. On the one hand, the carriers entering the transition region can be trapped, or collided with the traps and lose part of energy. On the other hand, the average free path of charge carriers in most of cases is larger than the thickness of the interface regions. In fact, the carriers cannot get enough energy from the external electric field to jump over the barrier. As a consequence, the carriers are trapped and cannot participate in the conduction. It can also be seen from the conductivity test results in Figure 5 that the addition of low-content nano-particles reduces the conductivity of EP, which provides the evidence that the carrier mobility in the material decreases and the breakdown strength increases.

When the content of nano particles is higher than 2.5wt%, the interface regions formed by nano particles are overlapped. Therefore, the thickness of the transition region is increased. When the thickness of the transition region is larger than the average free path of the carriers, charge carriers in the electric field can obtain sufficient energy and jump over the barrier into the matrix. Since the shallow trap level and density of samples with higher doping ratio are reduced, the interface region acts as a relatively high conduction region. Carriers transfer along the transmission channel and obtain higher energy, which results in the increase of mobility and the decrease of breakdown strength.

4.3 BREAKDOWN PROPERTY REGULATION AT DIFFERENT TEMPERATURES

The dielectric strength of EP decreases gradually with the increase of temperature; also, the decreasing rate of AC dielectric strength of EP increases significantly when the temperature is higher than 120 °C. According to the free volume breakdown theory [23], in the case of electronic breakdown, the breakdown strength E_b can be expressed as:

$$E_b = \frac{E_\mu}{el_E} \quad (7)$$

where e is the electron charge; l_E is the free volume length; E_μ is the threshold barrier for breakdown.

In general, the free volume of materials is affected by the glass transition process. There are evident changes when temperature reaches the glass transition temperature T_g . When the temperature is lower than T_g , the molecular chain of EP is rigid, and the EP is in the glass state. In this case, the temperature change has very little effect on the free volume. When the temperature is higher than T_g , the molecular chain of the material becomes soft, and EP reaches a viscous flow state or a high elastic state, in which the influence of temperature change on the free volume is evident [23, 24]. It can be concluded that the glass transition temperature of EP and its nanocomposite is about 120 °C. Therefore, the decreasing rate of AC breakdown strength varies near the temperature of 120 °C.

5 CONCLUSIONS

In this paper, nano-SiO₂ is doped into EP and the potential application of nanocomposites in HV motors is investigated. Epoxy resins with different doping ratio of SiO₂ are prepared and tested. The doping of nano-SiO₂ with a mass ratio of 0.5 wt% resulted to have a positive effect on the AC dielectric strength of EP, especially on the breakdown strength and T_g . Higher doping ratio resulted in an overlapped region between interfaces of nano particles, which leads to a decrease of the dielectric property for epoxy-based materials. In addition, a 6 kV stator coil was prepared and tested using doping ratio of 0.5% SiO₂. The coils doped with SiO₂ with a mass ratio of 0.5wt% obtained high performances over pure coils, especially in aspects such as: leakage current, PD properties, and dielectric losses. These improvements provide potential application of nano particles in HV motor insulation.

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